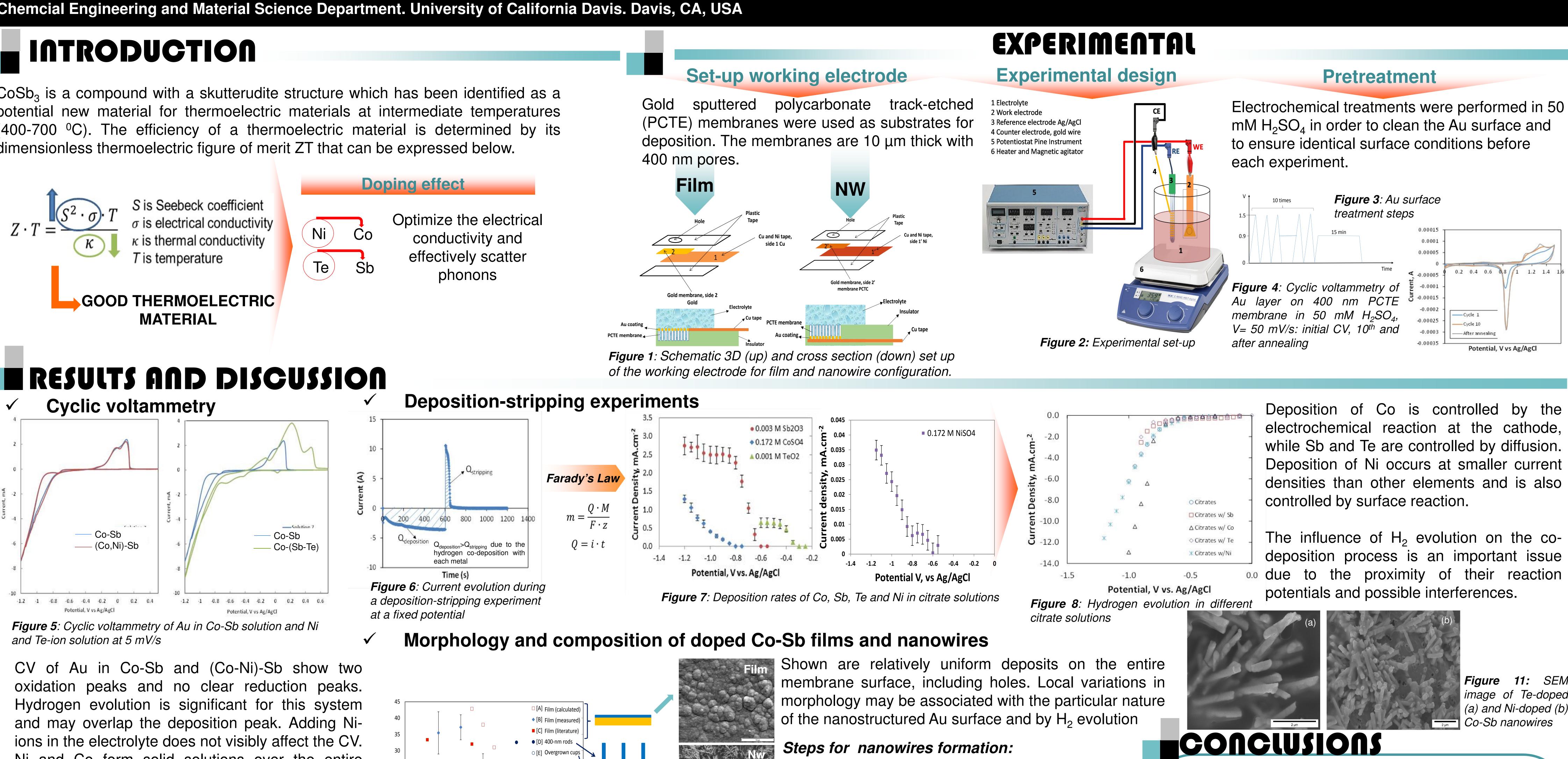
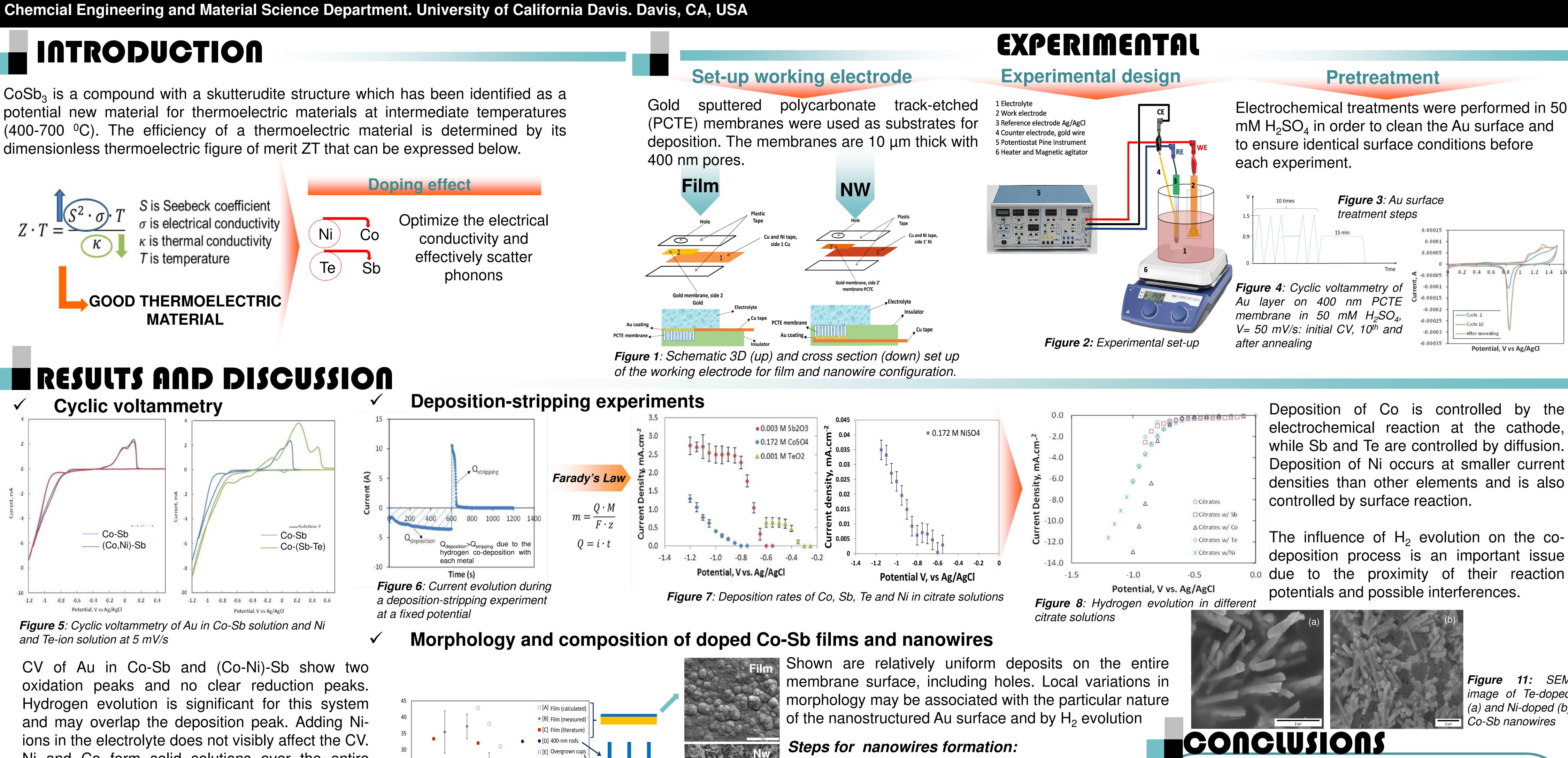
Ruxandra Vidu, Maria Perez-Page, Dat V. Quach, Xinyi Chen, and Pieter Stroeve





Ni and Co form solid solutions over the entire concentration range and this may be the reason why the two CVs are similar.

Addition of Te ions drastically changes the CV, i.e. additional deposition and stripping peaks appear.

The potential range for CV in Te-containing Co-Sb solution was extended in the positive direction from 0.5 to 0.7 V vs. Ag/AgCl to allow for the deposit to be removed from the surface during stripping.

# EFFECT OF DOPING WITH Co AND Te

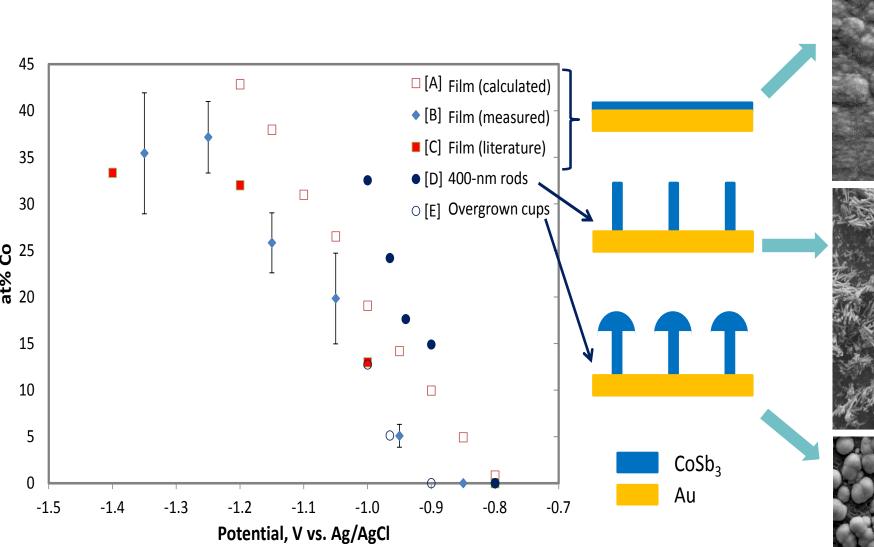


Figure 9: Composition of Co deposited from citrate solution with 0.172 M Co (II) and 0.006 M Sb (III): a) film prediction based on single solutions of Co (II) and Sb (III), b) film experimental results in solution with both Co (II) and Sb (III), c) film adjusted results from bibliograpy, d) 400 nm rods and e) overgrown mushroom caps.

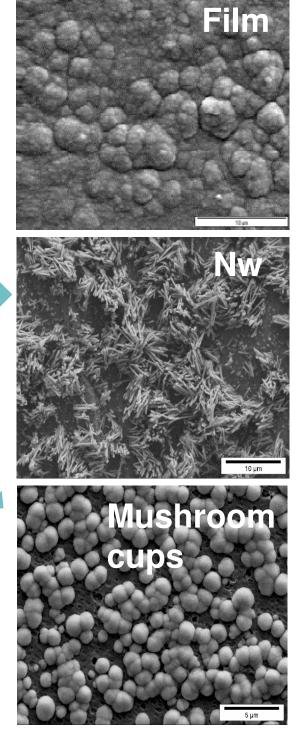
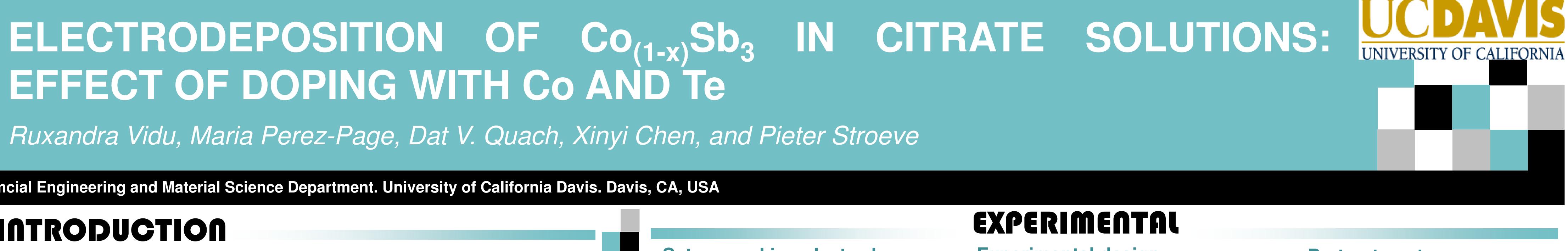


Figure 10:SEM images of Co-Sb in different configurations

> Table 1: EDS results obtained for Ni and Te doped nanowires



. Nucleation and growth of the nuclei inside pores 2. Continuous growth of nucleation which overlap inside the template

3. Nanowires continuous growth into mushroom cups.

Composition, at. %	Co-Sb	(Co-Ni)-Sb	Co-(Sb-Te)
Sb L	1.94+/-0.05	1.55+/-0.37	3.615+/-0.27
СоК	1.87+/-0.16	1.61+/-0.43	3.34+/-0.05
Ni K	-	0.13+/-0.09	-
Te K	-	-	0.39+/-0.05
(Co,Ni)/(Sb,Te)	0.96+/-0.06	1.12+/-0.06	0.83+/-0.05

- potential.

Figure 11: SEM image of Te-doped (a) and Ni-doped (b)

Addition of Ni in the electrolyte doesn't affect the CV, Co-Ni forms an alloy, however, addition of Te affects the CV which shows 2 different peaks.

Ni and Co deposition are controlled by reaction but Sb and Te are controlled by mass transfer.

• H<sub>2</sub> evolution is more important for Co and Ni deposition due to their potential being close to the  $H_2$  evolution

• Amount of Co is higher in nanowires than in films, or mushroom cups, due to the slow Sb deposition rate as limited by diffusion

• Ni and Te electrochemical doping of Co-Sb system affects the composition of the deposit but it has no effect on the nanowire morphology